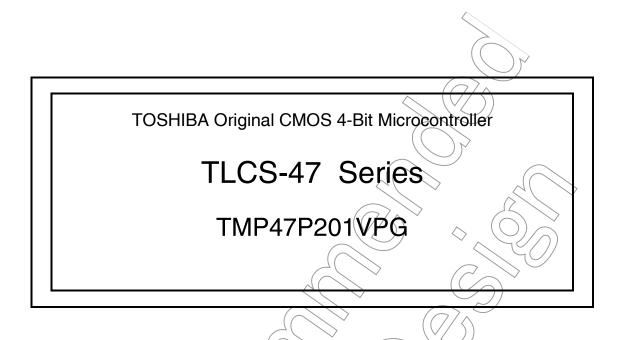
# **TOSHIBA**



## **TOSHIBA CORPORATION**

Semiconductor Company

# **Document Change Notification**

The purpose of this notification is to inform customers about the launch of the Pb free version of the device. The introduction of a Pb-free replacement affects the datasheet. Please understand that this notification is intended as a temporary substitute for a revision of the datasheet.

Changes to the datasheet may include the following, though not all of them may apply to this particular device.

1. Part number

Example: TMPxxxxxxFG TMPxxxxxxFG

All references to the previous part number were left unchanged in body text. The new part number is indicated on the prelims pages (cover page and this notification).

2. Package code and package dimensions

Example: LQFP100-P-1414-0.50C

LQFP100-P-1414-0.50F

All references to the previous package code and package dimensions were left unchanged in body text. The new ones are indicated on the prelims pages.

3. Addition of notes on lead solderability

Now that the device is Pb free, notes on lead solderability have been added.

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4. RESTRICTIONS ON PRODUCT USE

The previous (obsolete) provision might be left unchanged on page 1 of body text. A new replacement is included on the next page.

5. Publication date of the datasheet

The publication date at the lower right corner of the prelims pages applies to the new device.

#### 1. Part number

#### Package code and dimensions

Previous Part Number (in Body Text)	Previous Package Code (in Body Text)	New Part Number	New Package Code	ОТР
TMP47P201VP	P-DIP16-300-2.54A	TMP47P201VPG	DIP16-P-300-2.54A	_

<sup>\*:</sup> For the dimensions of the new package, see the attached Package Dimensions diagram.

#### 3. Addition of notes on lead solderability

The following solderability test is conducted on the new device

Lead solderability of Pb-free devices (with the G suffix)

Test	Test Conditions	Remark
Solderability	(1) Use of Lead (Pb) -solder bath temperature = 230°C -dipping time = 5 seconds -the number of times = once -use of R-type flux (2) Use of Lead (Pb)-Free -solder bath temperature = 245°C -dipping time = 5 seconds -the number of times = once -use of R-type flux	Leads with over/95% solder coverage till lead forming are acceptable.

#### 4. RESTRICTIONS ON PRODUCT USE

The following replaces the "RESTRICTIONS ON PRODUCT USE" on page 1 of body text.

#### RESTRICTIONS ON PRODUCT USE

20070701-EN

- The information contained herein is subject to change without notice.
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  compatibility. Please use these products in this document in compliance with all applicable laws and regulations that
  regulate the inclusion or use of controlled substances. Toshiba assumes no liability for damage or losses occurring
  as a result of noncompliance with applicable laws and regulations.
- For a discussion of how the reliability of microcontrollers can be predicted, please refer to Section 1.3 of the chapter entitled Quality and Reliability Assurance/Handling Precautions.

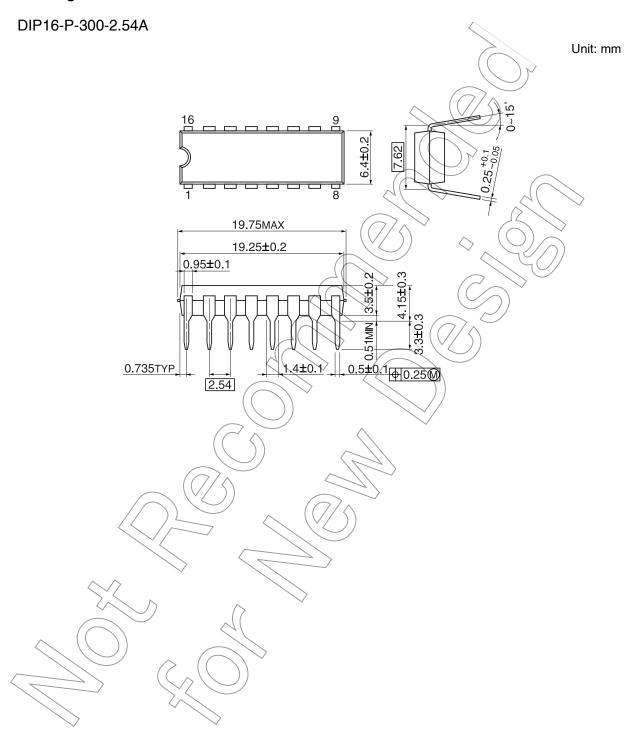
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#### 5. Publication date of the datasheet

The publication date of this datasheet is printed at the lower right corner of this notification.

(Annex)

# Package Dimensions



#### CMOS 4-Bit Microcontroller

#### TMP47P201VP

The TMP47P201V is the system evaluation LSI of TMP47C101/201 with a 16 Kbit one-time PROM. The TMP47P201V programs / verifies using an adapter socket to connect with PROM programmer, as it is in TMM27256AD.

In addition, the TMP47P201V and the TMP47C101/201 are pin compatible. The TMP47P201V operates as the same as the TMP47C101/201 by programming to the internal PROM.

Package

Adapter Socket

**RAM** 

Part No.

ROM

				3 . (	V - I
	TMP47P201VP	OTP 2048 × 8-bit	128 × 4-bit	P-DIP16-300-2:54A	BM1187
Pin Assignm	nent (Top Viev	v)			
				P-DIP16-300-2	.54A
	P-DIP16	6-300-2.54A			
XO	UT <b>↔</b> ☐ 1	16 2	← VDD		$\leq )$
×	$IIN \longrightarrow \Box$ 2	15 🗖 🗖	→ HØLD(INT1)		
VPP/RES	<u>ET</u> → □ 3	14 🗖 🗖	↔ R53/D7/A7	. ((//	
OE/R80(INT	72) ↔ □ 4	13 🗖 🗖	<> R52/D6/A6		S THE STATE OF THE
CE/R81(1	T2) <del>&lt;&gt;&gt;</del> □ 5	12 🗖 🗖	← R51/D5/A5		HEARNII"
D0/A0/A8/R	40 ↔ 🗆 6	11 🗔	← R50/D4/A4		
D1/A1/A9/R	41 ↔ 🗆 7	10 🛱 🗝	↔ R43/D3/A3		
ν	rss → 🗆 8	<b>2</b> 2 -	↔ R42/D2/A2/A	10	
			) <		TMP47P201VP

For a discussion of how the reliability of microcontrollers can be predicted, please refer to Section 1.3 of the chapter entitled Quality and Reliability Assurance / Handling Precautions.

Quality and Reliability Assurance / Handling Precautions.

TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.

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## **Pin Function**

The TMP47P201V has MCU mode and PROM mode.

(1) MCU mode The TMP47C101/201 and the TMP47P201V are pin compatible.

(2) PROM mode

Pin Name	Input / Output	Functions	Pin Name (MCU mode)
D0/A0/A8			R40
D1/A1/A9			R41
D2/A2/A10			R42
D3/A3	1/0	Page in out of a data of the first of the fi	R43
D4/A4	I/O	Data inputs/outputs or Address inputs	(R50)
D5/A5			R51
D6/A6			R52
D7/A7			R53
ŌĒ	Input	Output Enable input	R80
CE	mput	Chip Enable input	R81
VPP		+ 12.5 V / 5 V (Program supply voltage)	RESET
vcc	Power supply	+ 5 V	VDD
VSS		ov	VSS
HOLD	Input	PROM mode setting pin. Be fixed to low level.	HOLD
XIN	Input	input the clock from the external oscillator.	
хоит	Input (/	PROM control input	

#### **Operational Description**

The following is an explanation of hardware configuration and operation in relation to the TMP47P201V. The TMP47P201V is the same as the TMP47C101/201 except that an OTP is used instead of a built-in mask ROM.

#### 1. Operation mode

The TMP47P201V has an MCU mode and a PROM mode.

#### 1.1 MCU mode

The MCU mode is set by attaching a resonator between the XIN and XOUT pins. Operation in the MCU mode is the same as for the TMP47C101/201. In the TMP47P201V, RC oscillation is impossible.

#### 1.1.1 Program Memory

The program storage area is the same as for the TMP47C201. Don't use the addresses 400 to 7FF<sub>H</sub> when using the TMP47P101V to check TMP47C101 operation.

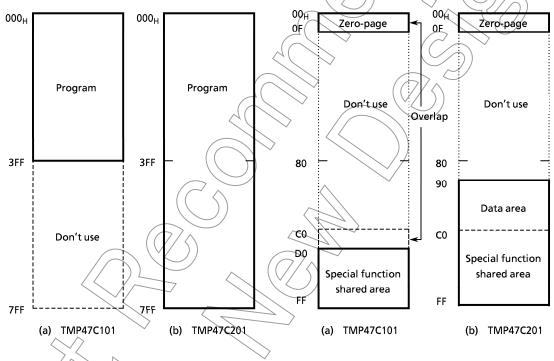


Figure 1-1. Program Area

Figure 1-2. RAM Address Assignment

#### 1.1.2 Data Memory

The TMP47P201V has  $128 \times 4$ -bit of data memory (RAM). When the TMP47P201V is used as the TMP47C101/201 evaluator, programming should be performed assuming that the RAM is assigned to address 00 to 0F<sub>H</sub> and D0 to FF<sub>H</sub> for TMP47C101, and 00 to 0F<sub>H</sub> and 90 to FF<sub>H</sub> for TMP47C201 as show in Figure 1-2. When the BM4721A (emulator) is used as the TMP47C101/201 evaluator, it is same.

Further, zero-page (addresses 00 to  $0F_H$ ) and special function shared area (stack location 0 to 3) are overlapped on the TMP47C101.

### 1.1.3 Input/Output Circuitry

(1) Control pins

This is the same as I/O code FA of the TMP47C101/201. In the TMP47P201V, RC oscillator is impossible. Connecting the resonator or inputting the extrernal clook to XIN pin are required when using as evaluator of I/O code FD, FE.

(2) I/O Ports

The input/output circuit of the TMP47P201V is the same as VO code FA or FD of the TMP47C101/201.

External resistance, for example, is required when using as evaluator of other I/O codes (FB, FE).

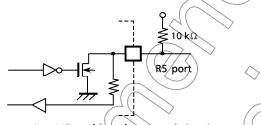


Figure 1-3. I/O code and external circuitry



#### 1.2 PROM mode

The TMP47P201V enters PROM mode by sending external clock signal from XIN pin when XOUT pin is at low level. In PROM mode, programs can be written or verified using a general-purpose PROM writer with an adapter socket (BM1187) being attached.

With the TMP47P201V, the PROM address input and data input/output use the same port. PROM mode control signal (XOUT) is used for switching between two functions. XOUT pin becomes control signal input after PROM mode is completed.

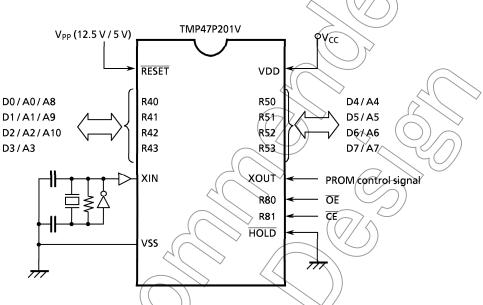


Figure 1-4. Setting for PROM mode

### 1.2.1 Program Writing

When writing a program, set a ROM type to "27256A" (programming voltage: 12.5 V). Since the TMP47P201V has a 2048 x 8-bit internal PROM (000 to 7FFH), set a stop address of a PROM writer to "7FFH". For a general-purpose PROM writer, use the writer which does not have or can release an electric signature mode.

Note: When the data written to OTP is same as the data of PROM programmer, there is the possibility that the security writing can not be executed, which is depended on the types of PROM programmers.

In this case, set the data of PROM programmer to "00" and execute the security writing after writing the data to OTP.

#### 1.2.2 High Speed Programming Mode

The program time can be greatly decreased by using this high speed programming mode. The device is set up in the high speed programming mode when the programming voltage (+ 12.5 V) is applied to the

Vpp terminal with  $V_{CC}=6\,V$  and  $\overline{CE}=V_{IH}$ . The programming is achieved by applying a single low level 1ms pulse the  $\overline{CE}$  input after addresses and data are stable. Then the programmed data is verified by using Program Verify Mode.

If the programmed data is not correct, another program pulse of 1ms is applied and then programmed data is verified. This should be repeated until the program operates correctly (max. 25 times).

After correctly programming the selected address, one additional program pulse with pulse width 3 times that needed for programming is applied.

When programming has been completed, the data in all addresses should be verified with  $V_{CC} = V_{PP} = 5 \text{ V}$ .

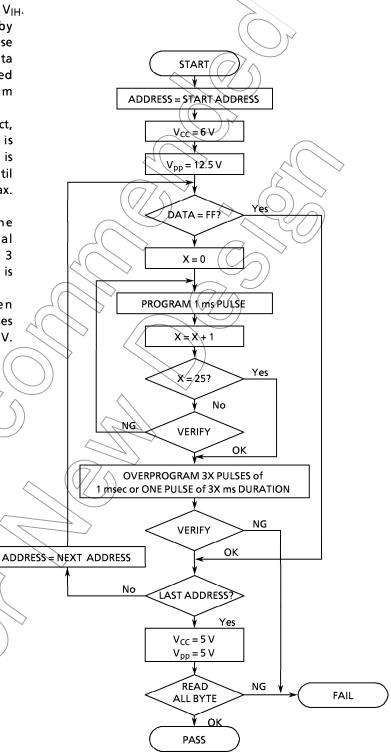


Figure 1-4. Flowchart

#### **Electrical Characteristics**

Absolute Maximum Ratings  $(V_{SS} = 0 V)$ 

Parameter	Symbol	Pins	Ratings	Unit
Supply Voltage	$V_{DD}$		_0.3 to 6.5	V
Program Voltage	$V_{PP}$	RESET / VPP		٧
Input Voltage	$V_{IN}$		$\sqrt{-0.3}$ to $V_{DD} + 0.3$	٧
Output Voltage	V <sub>OUT</sub>		– 0.3 to V <sub>DD</sub> + 0.3	<b>&gt;</b>
Output Current (Box 1 pin)	I <sub>OUT1</sub>	Port R4	30	A
Output Current (Per 1 pin)	I <sub>OUT2</sub>	Ports R5, R8, HOLD	3.2	mA
Output Current (Total)	Σ I <sub>OUT</sub>	Port R4	60	mΑ
Power Dissipation [Topr = 70°C]	PD		300	mW
Soldering Temperature (time)	Tsld		260 (10 s)	°C
Storage Temperature	Tstg		- 55 to 125	°C
Operating Temperature	Topr		-30 to 70)	°C

Note: The absolute maximum ratings are rated values which must not be exceeded during operation, even for an instant.

Any one of the ratings must not be exceeded. If any absolute maximum rating is exceeded, a device may break down or its performance may be degraded, causing it to catch fire or explode resulting in injury to the user. Thus, when designing products which include this device, ensure that no absolute maximum rating value will ever be exceeded.

**Recommended Operating Conditions** 

 $(V_{SS} = 0 \text{ V, Topr} = -30 \text{ to } 70^{\circ}\text{C})$ 

Parameter	Symbol	Pins	Conditions	Min	Max	Unit
			fc= 6.0 MHz	4.5		
Supply Voltage	$V_{DD}$		fc = 4.2 MHz	2.7	5.5	V
			HOLD mode	2.0		
	V <sub>IH1</sub> ((	Except Hysteresis Input	In the normal	$V_{DD} \times 0.7$		
Input High Voltage	V <sub>(H2</sub>	Hysteresis Input	operating area	$V_{DD} \times 0.75$	$V_{DD}$	V
	Уінз		ไก the HOLD mode	$V_{DD} \times 0.9$		
	/y <sub>IL1</sub>	Except Hysteresis Input	In the normal		$V_{DD} \times 0.3$	
Input Low Voltage	$\bigvee_{l = 2} \bigvee_{l = 2} V_{l L 2}$	Hysteresis Input	operating area	0	$V_{DD} \times 0.25$	V
	V <sub>IL</sub> 3		In the HOLD mode		$V_{DD} \times 0.1$	
Clask Francis A.	fc	XIN, XOUT	V <sub>DD</sub> = 4.5 to 5.5 V	V <sub>DD</sub> = 4.5 to 5.5 V		MHz
Clock Frequency	ıc .	AIN, AUUT	$V_{DD} = 2.7 \text{ to } 5.5 \text{ V}$	0.4	4.2	IVITZ

Note: The recommended operating conditions for a device are operating conditions under which it can be guaranteed that the device will operate as specified. If the device is used under operating conditions other than the recommended operating conditions (supply voltage, operating temperature range, specified AC/DC values etc.), malfunction may occur. Thus, when designing products which include this device, ensure that the recommended operating conditions for the device are always adhered to.

DC Characteristics

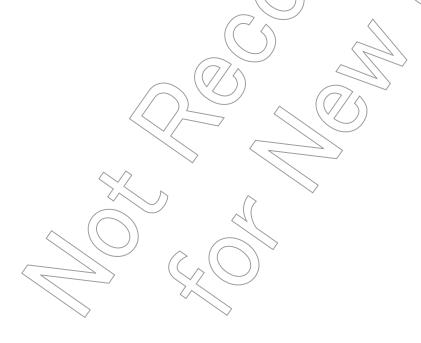
 $(V_{SS} = 0 \text{ V}, \text{ Topr} = -30 \text{ to } 70^{\circ}\text{C})$ 

Parameter	Symbol	Pins	Conditions	Min	Тур.	Max	Unit
Hysteresis Voltage	V <sub>HS</sub>	Hysteresis Input		1	0.7	-	٧
In must Commont	I <sub>IN1</sub>	RESET, HOLD	V <sub>DD</sub> = 5.5 V, V <sub>IN</sub> = 5.5 V 0 V	75)		± 2	^
Input Current	I <sub>IN2</sub>	Open drain output ports	$V_{DD} = 3.3 \text{ V}, V_{IN} = 3.3 \text{ V} \text{ V} \text{ V}$		_	±Ζ	μΑ
Input Resistance	R <sub>IN</sub>	RESET		100	220	450	ΚΩ
Output Leakage Current	I <sub>LO</sub>	Open drain output ports	$V_{DD} = 5.5 \text{ V}, \ V_{OUT} = 5.5 \text{ V}$	_	-(	2	μΑ
Output Low Voltage	V <sub>OL</sub>	Except XOUT and port R4	$V_{DD} = 4.5 \text{ V}, I_{OL} = 1.6 \text{ mA}$	-	7	0.4	<b>V</b>
Output Low Current	I <sub>OL1</sub>	Port R4	$V_{DD} = 4.5 V, V_{OL} = 1.0 V$	- (	20	) (	mA
Supply Current			$V_{DD} = 5.5 \text{ V}, \text{ fc} = 4 \text{ MHz}$	4	)2	) <b>4</b>	
(in the Normal	I <sub>DD</sub>		$V_{DD} = 3.0 \text{ V}, \text{ fc} = 4 \text{ MHz}$	⊋		2	mA
operating mode)			V <sub>DD</sub> = 3:0 V, fc = 400 kHz	(2)	0.5	1	
Supply Current (in the HOLD operating mode)	I <sub>DDH</sub>		V <sub>DD</sub> = 5.5 V	<u>)</u> -	0.5	10	μΑ

Note 1: Typ. values show those at Topr =  $25^{\circ}$ C,  $V_{DD} = 5$  V.

Note 2: Input Current I<sub>IN1</sub>: The current through resistor is not included.

Note 3: Supply Current:  $V_{IN} = 5.3 \text{ V} / 0.2 \text{ V} (V_{DD} = 5.5 \text{ V}) \text{ or } 2.8 \text{ V} / 0.2 \text{ V} (V_{DD} = 3.0 \text{ V})$ 



**AC Characteristics** 

 $(V_{SS} = 0 \text{ V}, \text{ Topr} = -30 \text{ to } 70^{\circ}\text{C})$ 

Parameter	Symbol	Conditions	Min	Тур.	Max	Unit
Instruction Code Time		VDD = 4.5 to 5.5 V	1.3	20		
Instruction Cycle Time	τ <sub>cy</sub>	VDD = 2.7 to 5.5 V	1.9		20	μS
High level Clock pulse Width	t <sub>WCH</sub>	Fan automod de de anomético	20			ns
Low level Clock pulse Width	t <sub>WCL</sub>	For external clock operation	80	_	1	115

**Recommended Oscillating Conditions** 

 $(V_{SS} = 0.4)$ ,  $V_{DD} = 2.7 \text{ to } 5.5 \text{ V}$ ,  $(T_{OD}) = -30 \text{ to } 70^{\circ}\text{C}$ 

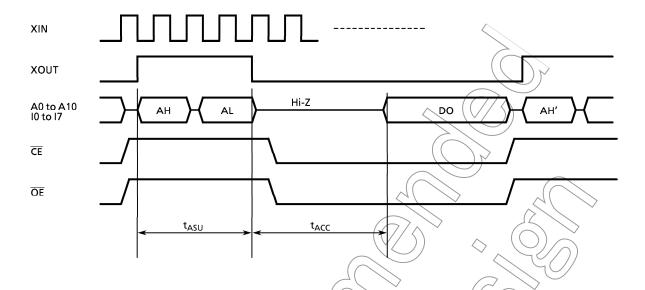
Recommended oscillating conditions of the TMP47P201V are equal to the TMP47C101/201's but RC oscillation is impossible.

DC/AC Characteristics

 $(V_{SS} = 0 V)$ 

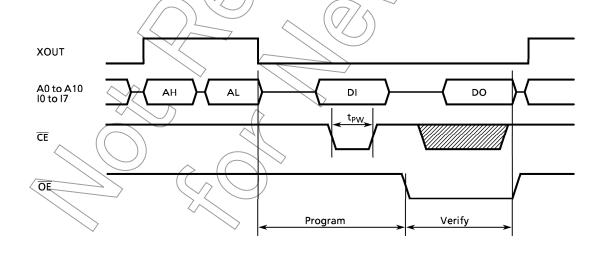
### (1) Read Operation

Parameter	Symbol	Condition	Min	Тур.	Max	Unit
Output Level High Voltage	VIHA		V <sub>CC</sub> × 0.7	-	V <sub>CC</sub>	٧
Output Level Low Voltage	V <sub>JL</sub> 4		0	_	V <sub>CC</sub> × 0.3	٧
Supply Voltage	Vec		4.75	_	6.0	V
Programming Voltage	$V_{PP}$		4.75	_	0.0	•
Address Set-up Time	t <sub>ASU</sub>		350	_	_	ns
Address Access Time	t <sub>ACC</sub>	V <sub>CC</sub> = 5.0 ± 0.25 V	-	-	300	ns



## (2) High Speed Programming Operation

Parameter	Symbol	Condition	>	Min	Тур.	Max	Unit
Input High Voltage	V <sub>IH4</sub>			V <sub>CC</sub> × 0.7	_	V <sub>CC</sub>	V
Input Low Voltage	V <sub>IL4</sub>			0))	-	V <sub>CC</sub> × 0.3	V
Supply Voltage	V <sub>CC</sub>			4.75	-	6.0	V
V <sub>PP</sub> Power Supply Voltage	VPP	$\langle \hat{\gamma} \rangle$		12.00	12.50	13.00	V
Programming Pulse Width	t <sub>PW</sub>	$V_{CC} = 6.0 \pm 0.25 \text{ V}$	R	0.95	1.0	1.05	ms



Note: DO; Data output (10 to 17), AL; Address input (A0 to A7)

DI; Data input (I0 to I7), AH; Address input (A8 to A10)

Note: There are some PROMprogrammer types which cannot program OTP.

In TMP47P201V, VPP pin is also used as RESET pin. To set a mode, REST/VPP pin must be set to "low" during 1 ms and more after the rising of power-on and the rising of VDD electrical power.

